

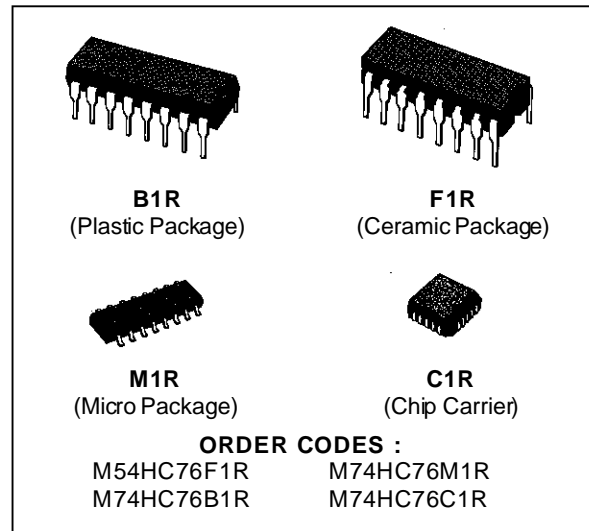
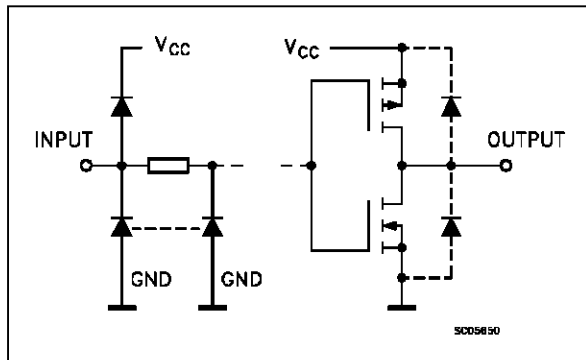
DUAL J-K FLIP FLOP WITH PRESET AND CLEAR

- HIGH SPEED
f_{MAX} = 65 MHz (TYP.) AT V_{CC} = 5 V
- LOW POWER DISSIPATION
I_{CC} = 2 μA (MAX.) AT 25 °C
- OUTPUT DRIVE CAPABILITY
10 LSTTL LOADS
- SYMMETRICAL OUTPUT IMPEDANCE
|I_{OH}| = I_{OL} = 4 mA (MIN.)
- BALANCED PROPAGATION DELAYS
t_{PLH} = t_{PHL}
- HIGH NOISE IMMUNITY
V_{NIH} = V_{NIL} = 28 % V_{CC} (MIN.)
- WIDE OPERATING VOLTAGE RANGE
V_{CC} (OPR) = 2 V TO 6 V
- PIN AND FUNCTION COMPATIBLE WITH 54/74LS76

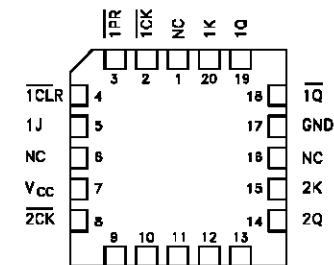
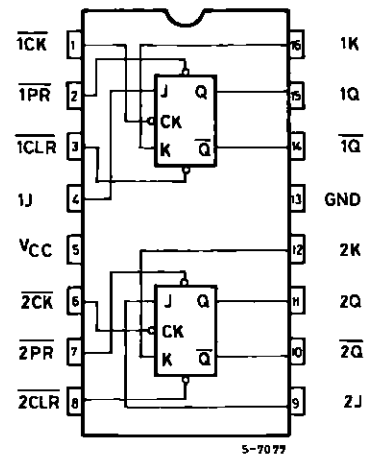
DESCRIPTION

The M54/74HC76 is a high speed CMOS DUAL J-K FLIP FLOP fabricated in silicon gate C²MOS technology. It has the same high speed performance of LSTTL combined with true CMOS low power consumption. Depending on with the logic level at the J and K inputs this device changes state on the negative going transition of the clock pulse. CLEAR and PRESET are independent of the clock and are accomplished by a logic low on the corresponding input. All inputs are equipped with protection circuits against static discharge and transient excess voltage.

INPUT AND OUTPUT EQUIVALENT CIRCUIT



PIN CONNECTIONS (top view)



NC =
No Internal
Connection

M54/M74HC76

TRUTH TABLE

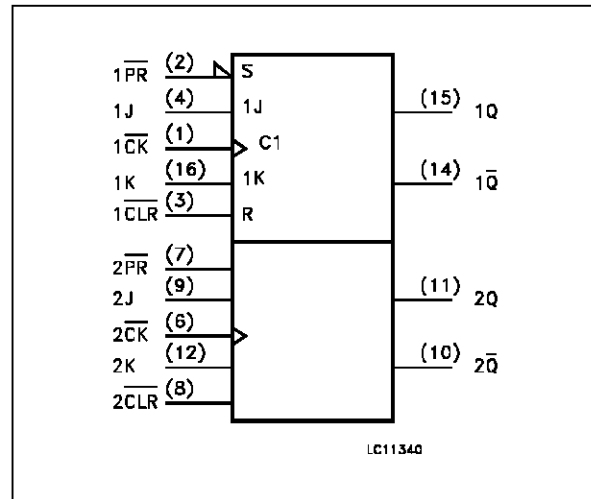
| INPUTS | | | | | OUTPUTS | | FUNCTION |
|--------|----|---|---|-----------|-------------|-------------|-----------|
| CLR | PR | J | K | CK | Q | \bar{Q} | |
| L | H | X | X | X | L | H | CLEAR |
| H | L | X | X | X | H | L | PRESET |
| L | L | X | X | X | H | H | |
| H | H | L | L | $\bar{1}$ | Q_n | \bar{Q}_n | NO CHANGE |
| H | H | L | H | $\bar{1}$ | L | H | |
| H | H | H | L | $\bar{1}$ | H | L | |
| H | H | H | H | $\bar{1}$ | \bar{Q}_n | Q_n | TOGGLE |
| H | H | X | X | $\bar{1}$ | Q_n | \bar{Q}_n | NO CHANGE |

X: Don't Care

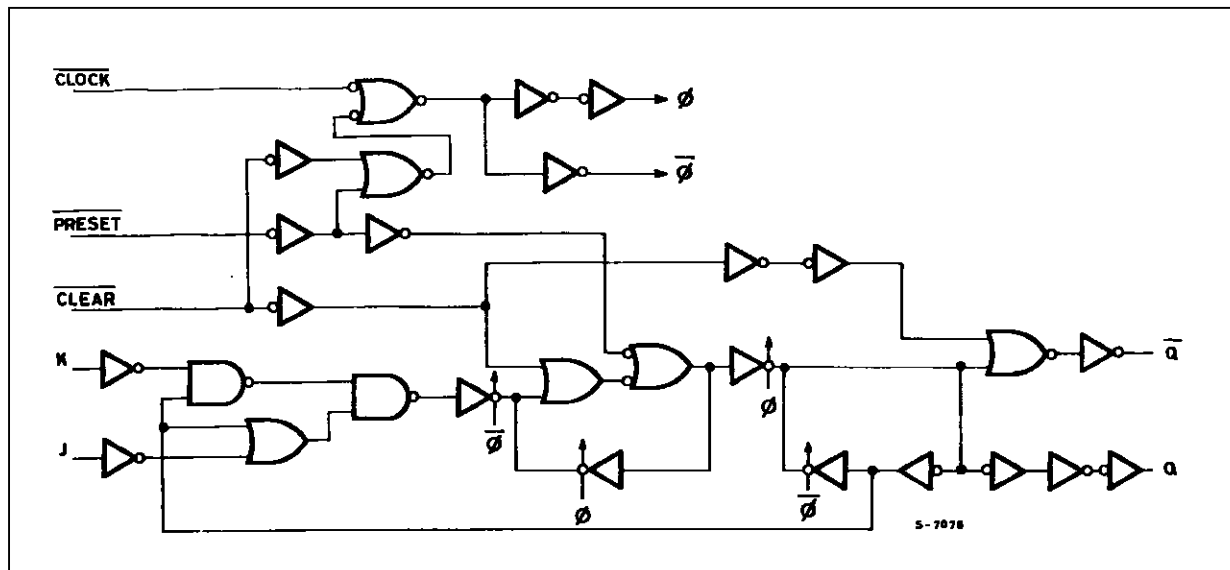
PIN DESCRIPTION

| PIN No | SYMBOL | NAME AND FUNCTION |
|--------|--------------------------|--|
| 1, 6 | $1\bar{CK}, 2\bar{CK}$ | Clock Input (HIGH to LOW edge triggered) |
| 2, 7 | $1\bar{PR}, 2\bar{PR}$ | Set Inputs (Active LOW) |
| 3, 8 | $1\bar{CLR}, 2\bar{CLR}$ | Asynchronous Reset Inputs (Active LOW) |
| 4, 9 | 1J, 2J | Data Inputs: Flip-Flop 1 and 2 |
| 10, 14 | $1\bar{Q}, 2\bar{Q}$ | Complement Flip-Flop Outputs |
| 11, 15 | 1Q, 2Q | True Flip-Flop Outputs |
| 16, 12 | 1K, 2K | Data Inputs: Flip-Flop 1 and 2 |
| 5 | GND | Ground (0V) |
| 13 | V _{CC} | Positive Supply Voltage |

IEC LOGIC SYMBOL



LOGIC DIAGRAM (1/2 Package)



ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|-------------------------------------|--|-------------------------------|------|
| V _{CC} | Supply Voltage | -0.5 to +7 | V |
| V _I | DC Input Voltage | -0.5 to V _{CC} + 0.5 | V |
| V _O | DC Output Voltage | -0.5 to V _{CC} + 0.5 | V |
| I _{IK} | DC Input Diode Current | ± 20 | mA |
| I _{OK} | DC Output Diode Current | ± 20 | mA |
| I _O | DC Output Source Sink Current Per Output Pin | ± 25 | mA |
| I _{CC} or I _{GND} | DC V _{CC} or Ground Current | ± 50 | mA |
| P _D | Power Dissipation | 500 (*) | mW |
| T _{stg} | Storage Temperature | -65 to +150 | °C |
| T _L | Lead Temperature (10 sec) | 300 | °C |

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

(*) 500 mW: ≅ 65 °C derate to 300 mW by 10mW/°C: 65 °C to 85 °C

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Value | Unit | |
|---------------------------------|---|---|-----------------------------------|----|
| V _{CC} | Supply Voltage | 2 to 6 | V | |
| V _I | Input Voltage | 0 to V _{CC} | V | |
| V _O | Output Voltage | 0 to V _{CC} | V | |
| T _{op} | Operating Temperature: M54HC Series M74HC Series | -55 to +125 -40 to +85 | °C °C | |
| t _r , t _f | Input Rise and Fall Time | V _{CC} = 2 V V _{CC} = 4.5 V V _{CC} = 6 V | 0 to 1000 0 to 500 0 to 400 | ns |

DC SPECIFICATIONS

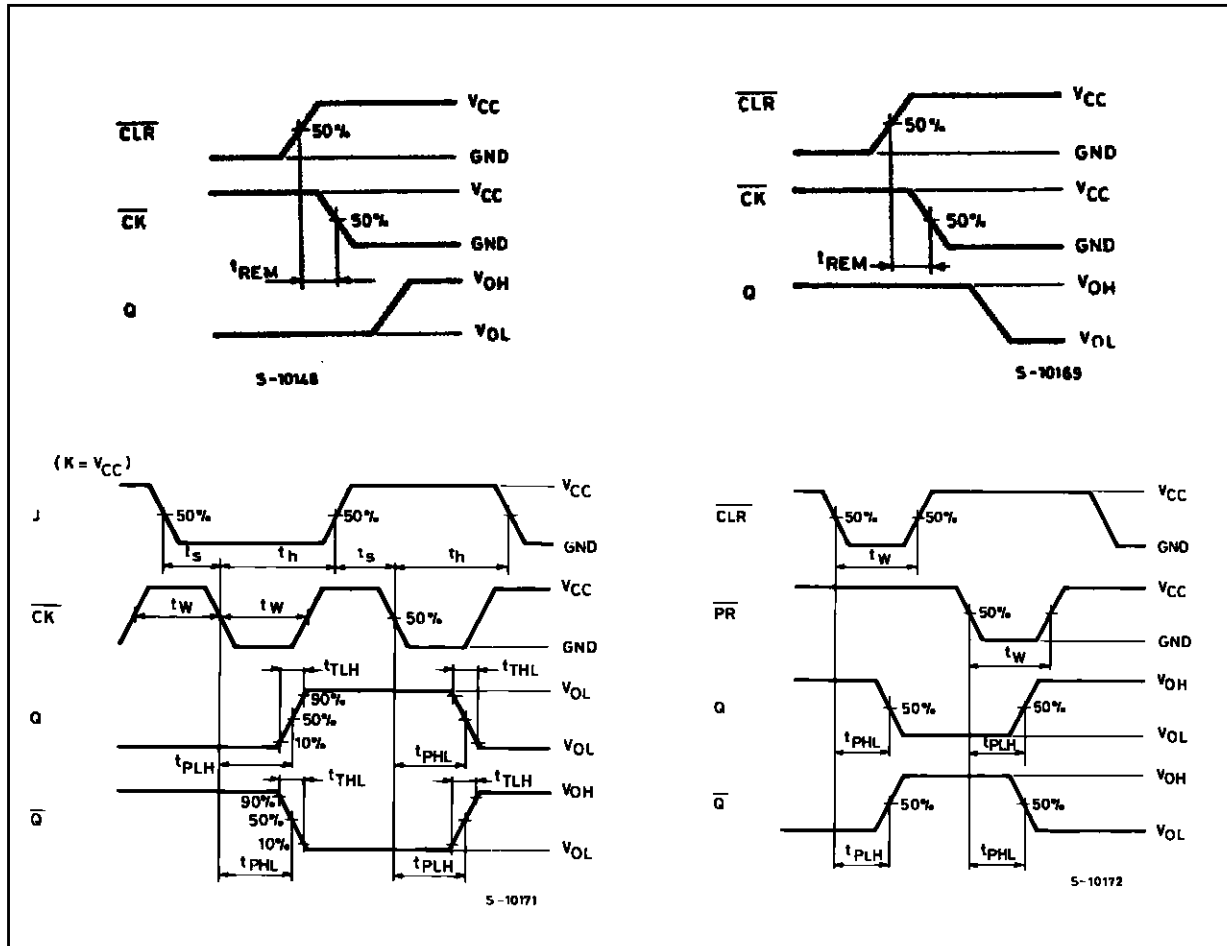
| Symbol | Parameter | Test Conditions | | Value | | | | | | Unit | | |
|-----------------|---------------------------|------------------------|--|---|-------------------------|------|----------------------|------|-----------------------|------|------|---|
| | | V _{CC} (V) | | T _A = 25 °C 54HC and 74HC | | | -40 to 85 °C 74HC | | -55 to 125 °C 54HC | | | |
| | | | | Min. | Typ. | Max. | Min. | Max. | Min. | | Max. | |
| V _{IH} | High Level Input Voltage | 2.0 | | 1.5 | | | 1.5 | | 1.5 | | V | |
| | | 4.5 | | 3.15 | | | 3.15 | | 3.15 | | | |
| | | 6.0 | | 4.2 | | | 4.2 | | 4.2 | | | |
| V _{IL} | Low Level Input Voltage | 2.0 | | | | 0.5 | | 0.5 | | 0.5 | V | |
| | | 4.5 | | | | 1.35 | | 1.35 | | 1.35 | | |
| | | 6.0 | | | | 1.8 | | 1.8 | | 1.8 | | |
| V _{OH} | High Level Output Voltage | 2.0 | V _I = V _{IH} or V _{IL} | I _O = -20 μA | 1.9 | 2.0 | | 1.9 | | 1.9 | V | |
| | | 4.5 | | | 4.4 | 4.5 | | 4.4 | | 4.4 | | |
| | | 6.0 | | | 5.9 | 6.0 | | 5.9 | | 5.9 | | |
| | | 4.5 | I _O = -4.0 mA | 4.18 | 4.31 | | 4.13 | | 4.10 | | | |
| | | 6.0 | | I _O = -5.2 mA | 5.68 | 5.8 | | 5.63 | | 5.60 | | |
| V _{OL} | Low Level Output Voltage | 2.0 | V _I = V _{IH} or V _{IL} | I _O = 20 μA | | 0.0 | 0.1 | | 0.1 | | 0.1 | V |
| | | 4.5 | | | | 0.0 | 0.1 | | 0.1 | | 0.1 | |
| | | 6.0 | | | | 0.0 | 0.1 | | 0.1 | | 0.1 | |
| | | 4.5 | | I _O = 4.0 mA | 0.17 | 0.26 | | 0.33 | | 0.40 | | |
| | | 6.0 | | | I _O = 5.2 mA | 0.18 | 0.26 | | 0.33 | | 0.40 | |
| I _I | Input Leakage Current | 6.0 | V _I = V _{CC} or GND | | | ±0.1 | | ±1 | | ±1 | μA | |
| I _{CC} | Quiescent Supply Current | 6.0 | V _I = V _{CC} or GND | | | 2 | | 20 | | 40 | μA | |

AC ELECTRICAL CHARACTERISTICS ($C_L = 50$ pF, Input $t_r = t_f = 6$ ns)

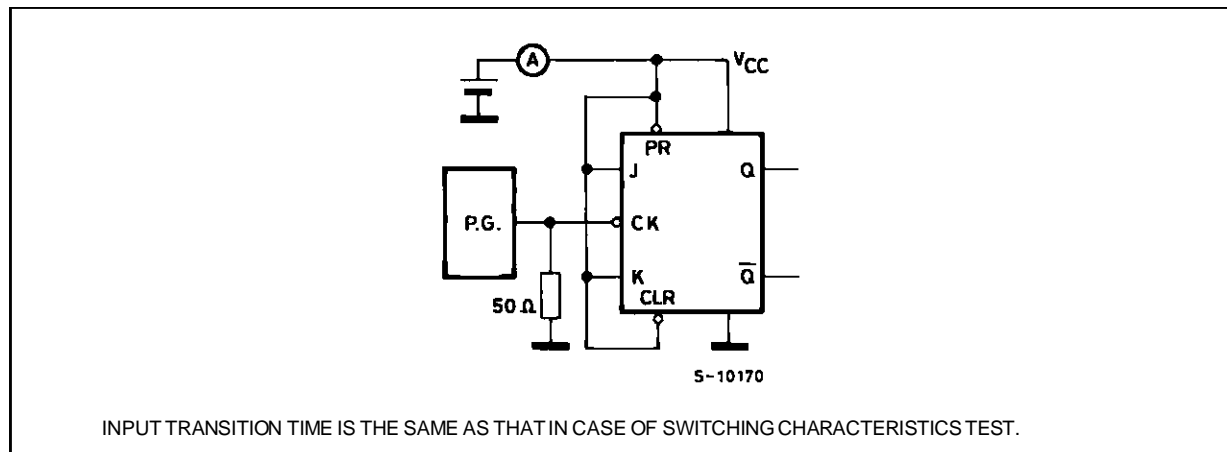
| Symbol | Parameter | Test Conditions | | Value | | | | | | Unit | |
|--|--|------------------------|--|---|------|------|----------------------|------|-----------------------|------|------|
| | | V _{CC} (V) | | T _A = 25 °C 54HC and 74HC | | | -40 to 85 °C 74HC | | -55 to 125 °C 54HC | | |
| | | | | Min. | Typ. | Max. | Min. | Max. | Min. | | Max. |
| t _{TLH} t _{THL} | Output Transition Time | 2.0 | | | 30 | 75 | | 95 | | 110 | ns |
| | | 4.5 | | | 8 | 15 | | 19 | | 22 | |
| | | 6.0 | | | 7 | 13 | | 16 | | 19 | |
| t _{PLH} t _{PHL} | Propagation Delay Time (CK - Q, \bar{Q}) | 2.0 | | | 60 | 125 | | 155 | | 190 | ns |
| | | 4.5 | | | 15 | 25 | | 31 | | 38 | |
| | | 6.0 | | | 13 | 21 | | 26 | | 32 | |
| t _{PLH} t _{PHL} | Propagation Delay Time (CLR, PR - Q, \bar{Q}) | 2.0 | | | 76 | 140 | | 175 | | 210 | ns |
| | | 4.5 | | | 18 | 28 | | 35 | | 42 | |
| | | 6.0 | | | 16 | 24 | | 30 | | 36 | |
| f _{MAX} | Maximum Clock Frequency | 2.0 | | 6.2 | 21 | | 5.0 | | 4.2 | | MHz |
| | | 4.5 | | 31 | 63 | | 25 | | 21 | | |
| | | 6.0 | | 37 | 67 | | 30 | | 25 | | |
| t _{W(H)} t _{W(L)} | Minimum Pulse Width (CLOCK) | 2.0 | | | 18 | 75 | | 95 | | 110 | ns |
| | | 4.5 | | | 6 | 15 | | 19 | | 22 | |
| | | 6.0 | | | 6 | 13 | | 16 | | 19 | |
| t _{W(L)} | Minimum Pulse Width (CLR, PR) | 2.0 | | | 22 | 75 | | 95 | | 110 | ns |
| | | 4.5 | | | 6 | 15 | | 19 | | 22 | |
| | | 6.0 | | | 6 | 13 | | 16 | | 19 | |
| t _s | Minimum Set-up Time | 2.0 | | | 25 | 75 | | 95 | | 110 | ns |
| | | 4.5 | | | 7 | 15 | | 19 | | 22 | |
| | | 6.0 | | | 6 | 13 | | 16 | | 19 | |
| t _h | Minimum Hold Time | 2.0 | | | | 0 | | 0 | | 0 | ns |
| | | 4.5 | | | | 0 | | 0 | | 0 | |
| | | 6.0 | | | | 0 | | 0 | | 0 | |
| t _{REM} | Minimum Removal Time (CLR, PR) | 2.0 | | | 20 | 75 | | 95 | | 110 | ns |
| | | 4.5 | | | 6 | 15 | | 19 | | 22 | |
| | | 6.0 | | | 5 | 13 | | 16 | | 19 | |
| C _{IN} | Input Capacitance | | | | 5 | 10 | | 10 | | 10 | pF |
| C _{PD} (*) | Power Dissipation Capacitance | | | | 38 | | | | | | pF |

(*) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$ (per FLIP/FLOP)

SWITCHING CHARACTERISTICS TEST WAVEFORM



TEST CIRCUIT I_{CC} (Opr.)



INPUT TRANSITION TIME IS THE SAME AS THAT IN CASE OF SWITCHING CHARACTERISTICS TEST.

Plastic DIP16 (0.25) MECHANICAL DATA

| DIM. | mm | | | inch | | |
|------|------|-------|------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| a1 | 0.51 | | | 0.020 | | |
| B | 0.77 | | 1.65 | 0.030 | | 0.065 |
| b | | 0.5 | | | 0.020 | |
| b1 | | 0.25 | | | 0.010 | |
| D | | | 20 | | | 0.787 |
| E | | 8.5 | | | 0.335 | |
| e | | 2.54 | | | 0.100 | |
| e3 | | 17.78 | | | 0.700 | |
| F | | | 7.1 | | | 0.280 |
| I | | | 5.1 | | | 0.201 |
| L | | 3.3 | | | 0.130 | |
| Z | | | 1.27 | | | 0.050 |



Ceramic DIP16/1 MECHANICAL DATA

| DIM. | mm | | | inch | | |
|------|------|-------|------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | | | 20 | | | 0.787 |
| B | | | 7 | | | 0.276 |
| D | | 3.3 | | | 0.130 | |
| E | 0.38 | | | 0.015 | | |
| e3 | | 17.78 | | | 0.700 | |
| F | 2.29 | | 2.79 | 0.090 | | 0.110 |
| G | 0.4 | | 0.55 | 0.016 | | 0.022 |
| H | 1.17 | | 1.52 | 0.046 | | 0.060 |
| L | 0.22 | | 0.31 | 0.009 | | 0.012 |
| M | 0.51 | | 1.27 | 0.020 | | 0.050 |
| N | | | 10.3 | | | 0.406 |
| P | 7.8 | | 8.05 | 0.307 | | 0.317 |
| Q | | | 5.08 | | | 0.200 |



SO16 (Narrow) MECHANICAL DATA

| DIM. | mm | | | inch | | |
|------|------------|------|------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | | | 1.75 | | | 0.068 |
| a1 | 0.1 | | 0.2 | 0.004 | | 0.007 |
| a2 | | | 1.65 | | | 0.064 |
| b | 0.35 | | 0.46 | 0.013 | | 0.018 |
| b1 | 0.19 | | 0.25 | 0.007 | | 0.010 |
| C | | 0.5 | | | 0.019 | |
| c1 | 45° (typ.) | | | | | |
| D | 9.8 | | 10 | 0.385 | | 0.393 |
| E | 5.8 | | 6.2 | 0.228 | | 0.244 |
| e | | 1.27 | | | 0.050 | |
| e3 | | 8.89 | | | 0.350 | |
| F | 3.8 | | 4.0 | 0.149 | | 0.157 |
| G | 4.6 | | 5.3 | 0.181 | | 0.208 |
| L | 0.5 | | 1.27 | 0.019 | | 0.050 |
| M | | | 0.62 | | | 0.024 |
| S | 8° (max.) | | | | | |



P013H

PLCC20 MECHANICAL DATA

| DIM. | mm | | | inch | | |
|------|------|------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 9.78 | | 10.03 | 0.385 | | 0.395 |
| B | 8.89 | | 9.04 | 0.350 | | 0.356 |
| D | 4.2 | | 4.57 | 0.165 | | 0.180 |
| d1 | | 2.54 | | | 0.100 | |
| d2 | | 0.56 | | | 0.022 | |
| E | 7.37 | | 8.38 | 0.290 | | 0.330 |
| e | | 1.27 | | | 0.050 | |
| e3 | | 5.08 | | | 0.200 | |
| F | | 0.38 | | | 0.015 | |
| G | | | 0.101 | | | 0.004 |
| M | | 1.27 | | | 0.050 | |
| M1 | | 1.14 | | | 0.045 | |



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